

# Agilent ADA-4643 Silicon Bipolar Darlington Amplifier Data Sheet

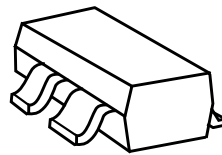
## Description

Agilent Technologies' ADA-4643 is an economical, easy-to-use, general purpose silicon bipolar RFIC gain block amplifiers housed in a 4-lead SC-70 (SOT-343) surface mount plastic package which requires only half the board space of a SOT-143 package.

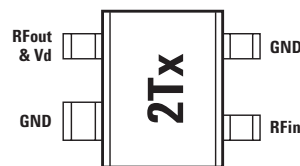
The Darlington feedback structure provides inherent broad bandwidth performance, resulting in useful operating frequency up to 2.5 GHz. This is an ideal device for small-signal gain cascades or IF amplification.

ADA-4643 is fabricated using Agilent's HP25 silicon bipolar process, which employs a double-diffused single polysilicon process with self-aligned submicron emitter geometry. The process is capable of simultaneous high  $f_T$  and high NPN breakdown (25 GHz  $f_T$  at 6V BVCEO). The process utilizes industry standard device oxide isolation technologies and submicron aluminum multilayer interconnect to achieve superior performance, high uniformity, and proven reliability.

## Surface Mount Package SOT-343



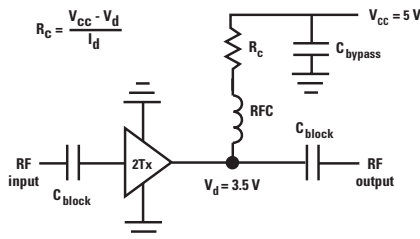
## Pin Connections and Package Marking



**Note:**  
Top View. Package marking provides orientation and identification.

"2T" = Device Code  
"x" = Date code character  
identifies month of manufacture.

## Typical Biasing Configuration



## Features

- Small Signal gain amplifier
- Operating frequency DC – 2.5 GHz
- Unconditionally stable
- 50 Ohms input & output
- Flat, Broadband Frequency Response up to 1 GHz
- Operating Current: 20 to 60 mA
- Industry standard SOT-343 package

## Specifications

900 MHz, 3.5V, 35 mA (typ.)

- 17 dB associated gain
- 13.4 dBm  $P_{1dB}$
- 28.3 dBm  $OIP_3$
- 4 dB noise figure
- VSWR < 2.2 throughput operating frequency
- Single supply, typical  $I_d = 35$  mA

## Applications

- Cellular/PCS/WLL base stations
- Wireless data/WLAN
- Fiber-optic systems
- ISM



Agilent Technologies

## ADA-4643 Absolute Maximum Ratings<sup>[1]</sup>

Symbol	Parameter	Units	Absolute Maximum
$I_d$	Device Current	mA	70
$P_{diss}$	Total Power Dissipation <sup>[2]</sup>	mW	270
$P_{in\ max.}$	RF Input Power	dBm	18
$T_j$	Channel Temperature	°C	150
$T_{STG}$	Storage Temperature	°C	-65 to 150
$\theta_{jc}$	Thermal Resistance <sup>[3]</sup>	°C/W	152

### Notes:

1. Operation of this device above any one of these parameters may cause permanent damage.
2. Ground lead temperature is 25°C. Derate 6.6 mW/°C for TL >109°C.
3. Junction-to-case thermal resistance measured using 150°C Liquid Crystal Measurement method.

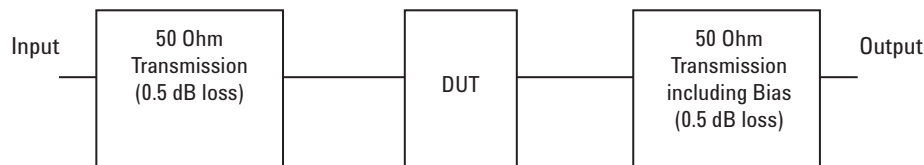
## ADA-4643 Electrical Specifications

$T_A = 25^\circ\text{C}$ ,  $Z_0 = 50\Omega$ ,  $P_{in} = -25\ \text{dBm}$ ,  $I_d = 35\ \text{mA}$  (unless specified otherwise)

Symbol	Parameter and Test Condition: $I_d = 35\ \text{mA}$ , $Z_0 = 50\Omega$	Frequency	Units	Min.	Typ.	Max.	Std. Dev.
$V_d$	Device Voltage $I_d = 35\ \text{mA}$		V	3.2	3.5	3.9	
$G_p$	Power Gain ( $ S_{21} ^2$ )	100 MHz 900 MHz <sup>[1,2]</sup>	dB	15.5	17.5 17.0	18.5	
$\Delta G_p$	Gain Flatness	100 to 900 MHz 0.1 to 2 GHz	dB		0.5 1.8		
$F_{3dB}$	3 dB Bandwidth		GHz		3.2		
$VSMR_{in}$	Input Voltage Standing Wave Ratio	0.1 to 6 GHz			2.0:1		
$VSMR_{out}$	Output Voltage Standing Wave Ratio	0.1 to 6 GHz			1.6:1		
NF	50Ω Noise Figure	100 MHz 900 MHz <sup>[1,2]</sup>	dB		3.9 4.0		0.07 0.1
$P_{1dB}$	Output Power at 1dB Gain Compression	100 MHz 900 MHz <sup>[1,2]</sup>	dBm		14.7 13.4		
$OIP_3$	Output 3 <sup>rd</sup> Order Intercept Point	100 MHz <sup>[3]</sup> 900 MHz <sup>[1,2,3]</sup>	dBm		29.0 28.3		
DV/dT	Device Voltage Temperature Coefficient		mV/°C		-5.3		

### Notes:

1. Typical value determined from a sample size of 500 parts from 3 wafers.
2. Measurement obtained using production test board described in the block diagram below.
3. I) 900 MHz  $OIP_3$  test condition:  $F_1 = 900\ \text{MHz}$ ,  $F_2 = 905\ \text{MHz}$  and  $P_{in} = -25\ \text{dBm}$  per tone.  
II) 100 MHz  $OIP_3$  test condition:  $F_1 = 100\ \text{MHz}$ ,  $F_2 = 105\ \text{MHz}$  and  $P_{in} = -25\ \text{dBm}$  per tone.



Block diagram of 900 MHz production test board used for  $V_d$ , Gain,  $P_{1dB}$ ,  $OIP_3$ , and NF measurements. Circuit losses have been de-embedded from actual measurements.

### Product Consistency Distribution Charts at 900 MHz, $I_d = 35$ mA

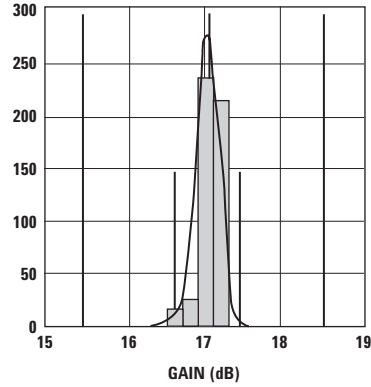


Figure 1. Gain distribution @ 35 mA.  
LSL = 15.5, Nominal = 17, USL = 18.5

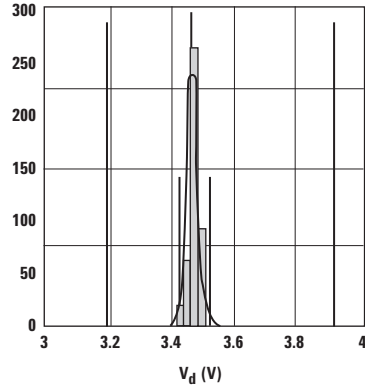


Figure 2.  $V_d$  distribution @ 35 mA.  
LSL = 3.2, Nominal = 3.5, USL = 3.9

**Notes:**

1. Statistics distribution determined from a sample size of 500 parts taken from 3 different wafers.
2. Future wafers allocated to this product may have typical values anywhere between the minimum and maximum specification limits.

### ADA-4643 Typical Performance Curves (at 25°C, unless specified otherwise)

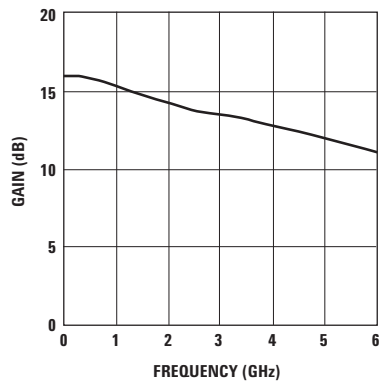


Figure 3. Gain vs. Frequency at  $I_d = 35$  mA.

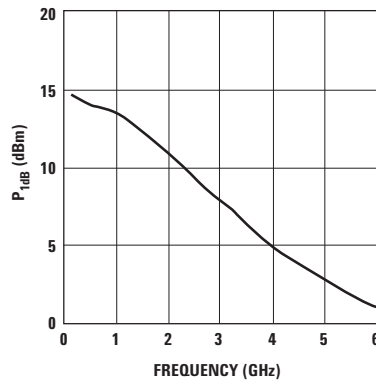


Figure 4.  $P_{1dB}$  vs. Frequency at  $I_d = 35$  mA.

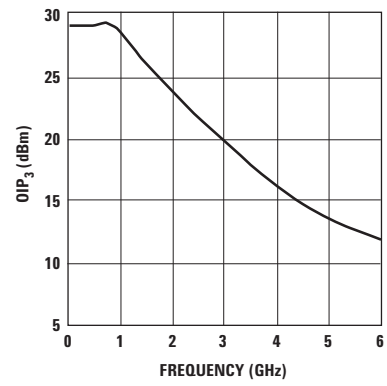


Figure 5.  $OIP_3$  vs. Frequency at  $I_d = 35$  mA.

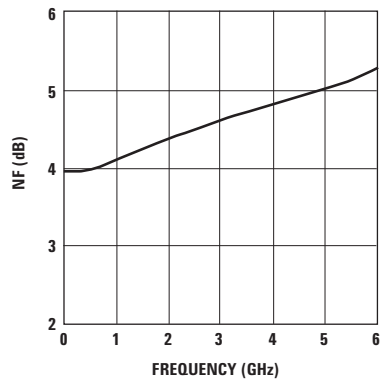


Figure 6. NF vs. Frequency at  $I_d = 35$  mA.

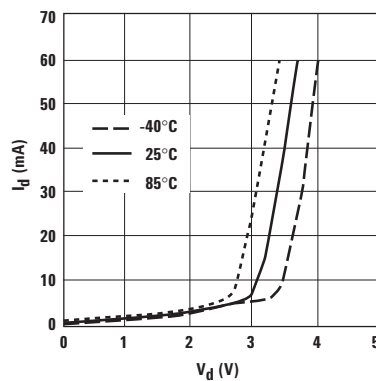


Figure 7.  $I_d$  vs.  $V_d$  and Temperature.

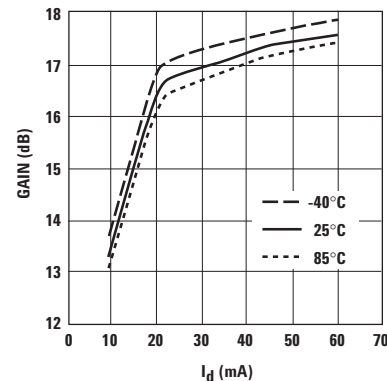


Figure 8. Gain vs.  $I_d$  and Temperature at 900 MHz.

ADA-4643 Typical Performance Curves (at 25°C, unless specified otherwise), continued

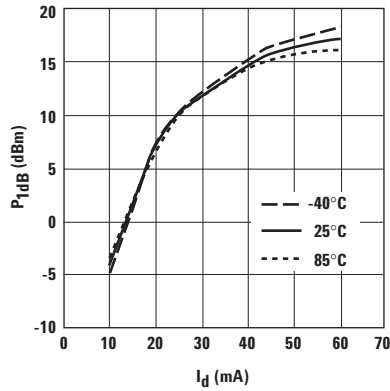


Figure 9. P<sub>1dB</sub> vs. I<sub>d</sub> and Temperature at 900 MHz.

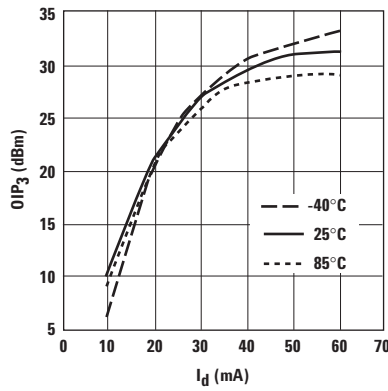


Figure 10. OIP<sub>3</sub> vs. I<sub>d</sub> and Temperature at 900 MHz.

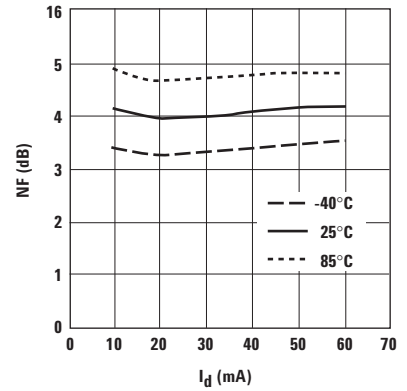


Figure 11. NF vs. I<sub>d</sub> and Temperature at 900 MHz.

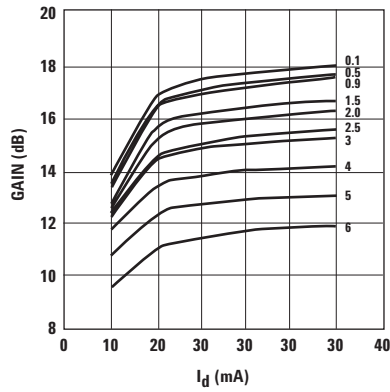


Figure 12. Gain vs. I<sub>d</sub> and Frequency (GHz).

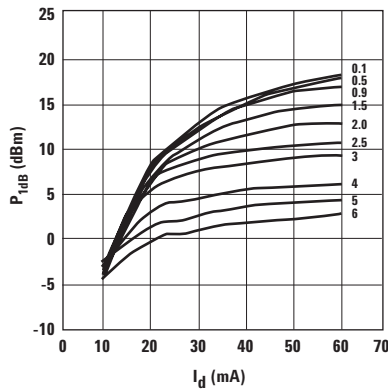


Figure 13. P<sub>1dB</sub> vs. I<sub>d</sub> and Frequency (GHz).

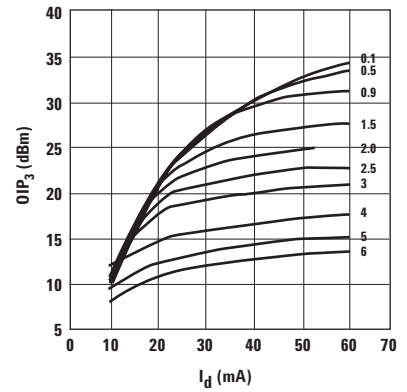


Figure 14. OIP<sub>3</sub> vs. I<sub>d</sub> and Frequency (GHz).

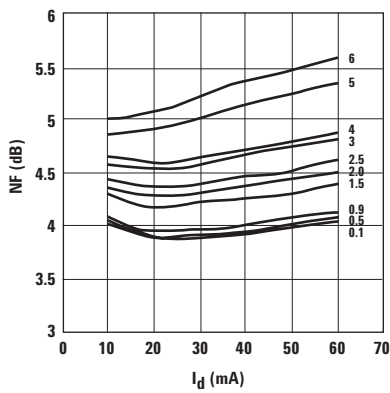


Figure 15. NF vs. I<sub>d</sub> and Frequency (GHz).

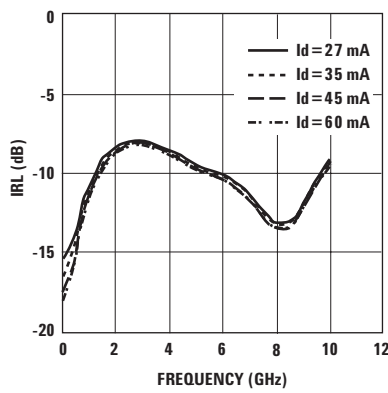


Figure 16. Input Return Loss vs. I<sub>d</sub> and Frequency (GHz).

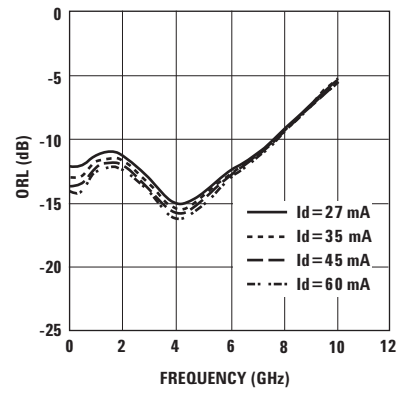


Figure 17. Output Return Loss vs. I<sub>d</sub> and Frequency (GHz).

ADA-4643 Typical Scattering Parameters,  $T_A = 25^\circ\text{C}$ ,  $I_d = 27\text{ mA}$

Freq. GHz	S <sub>11</sub>			S <sub>21</sub>			S <sub>12</sub>		S <sub>22</sub>		K
	Mag.	Ang.	dB	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.		
0.1	0.172	1.1	17.2	7.246	175.9	0.093	-0.8	0.245	-4.1	1.1	
0.5	0.202	10	17.04	7.113	160.2	0.091	-4.5	0.245	-12.6	1.1	
0.9	0.277	12.3	16.67	6.814	144.7	0.088	-7.4	0.269	-20.4	1.1	
1.0	0.286	9.9	16.56	6.726	141.1	0.087	-7.9	0.274	-23.1	1.1	
1.5	0.349	-2.8	15.98	6.292	124.2	0.083	-9.3	0.28	-37.6	1.1	
1.9	0.375	-11.3	15.54	5.984	111.4	0.080	-9.5	0.273	-48.9	1.2	
2.0	0.382	-13.8	15.44	5.918	108.3	0.08	-9.5	0.271	-51.7	1.2	
2.5	0.397	-24.2	14.93	5.581	93.2	0.078	-8.9	0.249	-65.8	1.2	
3.0	0.402	-34.7	14.47	5.29	78.6	0.078	-7.8	0.22	-81.7	1.3	
3.5	0.394	-46	14.02	5.021	64.2	0.079	-6.6	0.192	-100.9	1.3	
4.0	0.378	-58.7	13.58	4.775	50	0.082	-5.4	0.176	-123.8	1.3	
4.5	0.361	-73.1	13.16	4.55	35.9	0.087	-4.6	0.179	-148.6	1.3	
5.0	0.340	-89.3	12.64	4.284	21.9	0.094	-4.9	0.191	-169.9	1.3	
5.5	0.328	-107.1	12.15	4.05	8.3	0.102	-5.9	0.212	173.3	1.2	
6.0	0.318	-124.8	11.6	3.803	-5.4	0.112	-8.3	0.233	158.2	1.2	
6.5	0.299	-141.1	11.09	3.584	-18.6	0.124	-11.5	0.25	141.6	1.1	
7.0	0.274	-159.7	10.56	3.371	-32	0.138	-16.5	0.27	123	1.1	
7.5	0.243	177.3	9.96	3.149	-45.6	0.150	-22.8	0.3	103.6	1.1	
8.0	0.222	148.7	9.29	2.914	-59.1	0.161	-30	0.337	84.8	1.1	
8.5	0.226	119.9	8.41	2.632	-71.8	0.168	-36.7	0.381	70.1	1.1	
9.0	0.26	95.4	7.62	2.406	-83.7	0.177	-43	0.429	58.4	1.1	
9.5	0.305	75.2	6.67	2.155	-96.1	0.187	-49.9	0.481	48.4	1.1	
10.0	0.356	60.1	5.82	1.954	-107.1	0.195	-57.3	0.529	39.7	1	

**Notes:**

1. S-parameters are measured on a microstrip line made on 0.025 inch thick alumina carrier. The input reference plane is at the end of the input lead. The output reference plane is at the end of the output lead.

**ADA-4643 Typical Scattering Parameters,  $T_A = 25^\circ\text{C}$ ,  $I_d = 35\text{ mA}$**

Freq. GHz	S <sub>11</sub>			S <sub>21</sub>			S <sub>12</sub>		S <sub>22</sub>		K
	Mag.	Ang.	dB	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.		
0.1	0.151	1.6	17.51	7.504	175.9	0.091	-0.8	0.223	-4.1	1.1	
0.5	0.185	13.1	17.35	7.367	160.1	0.09	-4.2	0.224	-11.7	1.1	
0.9	0.265	14.9	16.98	7.06	144.6	0.087	-7	0.251	-19	1.1	
1.0	0.272	12.4	16.86	6.97	140.9	0.086	-7.5	0.256	-21.7	1.1	
1.5	0.340	-0.7	16.27	6.511	123.9	0.082	-8.8	0.264	-36.2	1.1	
1.9	0.367	-9.5	15.82	6.178	111	0.080	-9.1	0.259	-47.6	1.2	
2.0	0.373	-12.1	15.72	6.107	108	0.079	-9.1	0.256	-50.3	1.2	
2.5	0.39	-22.7	15.19	5.745	92.8	0.078	-8.5	0.236	-64.4	1.2	
3.0	0.395	-33	14.71	5.436	78.3	0.077	-7.3	0.209	-80.4	1.3	
3.5	0.387	-44.3	14.23	5.149	63.9	0.079	-6	0.181	-99.9	1.3	
4.0	0.370	-57.4	13.79	4.89	49.9	0.082	-4.8	0.166	-123.4	1.3	
4.5	0.353	-71.6	13.36	4.657	35.9	0.087	-3.9	0.17	-148.9	1.3	
5.0	0.332	-87.7	12.84	4.383	21.9	0.093	-4.2	0.185	-170.6	1.2	
5.5	0.319	-106	12.34	4.141	8.3	0.102	-5.1	0.207	172.5	1.2	
6.0	0.310	-123.6	11.8	3.889	-5.4	0.112	-7.5	0.23	157.5	1.2	
6.5	0.293	-140.2	11.28	3.666	-18.6	0.124	-10.8	0.248	140.9	1.1	
7.0	0.266	-158.8	10.75	3.449	-32	0.138	-15.8	0.27	122.3	1.1	
7.5	0.238	177.8	10.15	3.219	-45.5	0.151	-22.2	0.301	103	1.1	
8.0	0.217	148.5	9.48	2.979	-59	0.161	-29.3	0.34	84.3	1.1	
8.5	0.222	119.5	8.62	2.697	-71.7	0.169	-36.1	0.385	69.6	1.1	
9.0	0.256	95	7.81	2.458	-83.4	0.178	-42.5	0.434	57.9	1.1	
9.5	0.300	74.9	6.88	2.208	-95.8	0.188	-49.5	0.486	47.9	1	
10.0	0.357	59.1	6.01	1.996	-107.2	0.196	-56.9	0.534	39.2	1	

**Notes:**

1. S-parameters are measured on a microstrip line made on 0.025 inch thick alumina carrier. The input reference plane is at the end of the input lead. The output reference plane is at the end of the output lead.

**ADA-4643 Typical Scattering Parameters,  $T_A = 25^\circ\text{C}$ ,  $I_d = 45\text{ mA}$**

Freq. GHz	$S_{11}$		dB	$S_{21}$		$S_{12}$		$S_{22}$		K
	Mag.	Ang.		Mag.	Ang.	Mag.	Ang.	Mag.	Ang.	
0.1	0.137	2.4	17.72	7.691	175.9	0.09	-0.7	0.207	-4	1.1
0.5	0.174	15.3	17.56	7.547	160	0.089	-4	0.209	-10.9	1.1
0.9	0.257	17.4	17.19	7.234	144.5	0.086	-6.8	0.238	-17.6	1.1
1.0	0.267	14.7	17.08	7.144	140.8	0.085	-7.2	0.243	-20.3	1.1
1.5	0.334	0.7	16.47	6.664	123.7	0.081	-8.5	0.253	-34.8	1.1
1.9	0.36	-8.4	16.01	6.317	110.7	0.079	-8.7	0.249	-46.1	1.1
2.0	0.367	-10.9	15.91	6.241	107.7	0.079	-8.7	0.247	-48.9	1.2
2.5	0.386	-21.6	15.36	5.862	92.5	0.077	-8.1	0.227	-62.9	1.2
3.0	0.39	-32.1	14.86	5.534	78	0.077	-7	0.201	-78.9	1.2
3.5	0.382	-43.4	14.38	5.237	63.6	0.078	-5.7	0.174	-98.4	1.3
4.0	0.365	-56.4	13.93	4.971	49.7	0.081	-4.5	0.159	-122.3	1.3
4.5	0.348	-70.8	13.5	4.732	35.7	0.086	-3.6	0.164	-148.3	1.3
5.0	0.327	-86.8	12.97	4.45	21.7	0.093	-3.9	0.179	-170.4	1.2
5.5	0.314	-105.1	12.48	4.205	8.2	0.101	-4.8	0.202	172.6	1.2
6.0	0.304	-122.8	11.93	3.947	-5.5	0.112	-7.1	0.226	157.6	1.2
6.5	0.287	-139.6	11.41	3.721	-18.7	0.124	-10.4	0.245	140.9	1.1
7.0	0.26	-159.1	10.88	3.498	-32	0.138	-15.4	0.268	122.3	1.1
7.5	0.232	177.6	10.28	3.264	-45.6	0.151	-21.8	0.3	102.9	1.1
8.0	0.213	147.8	9.6	3.02	-59.1	0.161	-28.9	0.339	84.2	1.1
8.5	0.218	120.2	8.7	2.724	-71.7	0.169	-35.8	0.385	69.5	1.1
9.0	0.26	94.2	7.95	2.498	-83.7	0.179	-42.1	0.434	57.9	1.1
9.5	0.303	74	6.98	2.233	-96.2	0.189	-49.2	0.487	47.9	1
10.0	0.352	59.4	6.14	2.027	-107.1	0.196	-56.6	0.535	39.1	1

**Notes:**

1. S-parameters are measured on a microstrip line made on 0.025 inch thick alumina carrier. The input reference plane is at the end of the input lead. The output reference plane is at the end of the output lead.

**ADA-4643 Typical Scattering Parameters,  $T_A = 25^\circ\text{C}$ ,  $I_d = 60\text{ mA}$**

Freq. GHz	$S_{11}$			$S_{21}$			$S_{12}$		$S_{22}$		K
	Mag.	Ang.	dB	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.		
0.1	0.126	2.4	17.88	7.834	175.9	0.089	-0.7	0.194	-3.8	1.1	
0.5	0.165	18.1	17.73	7.696	159.9	0.088	-3.8	0.196	-9.9	1.1	
0.9	0.252	19.6	17.36	7.377	144.3	0.085	-6.4	0.227	-16.1	1.1	
1.0	0.261	16.4	17.24	7.28	140.6	0.085	-6.9	0.233	-18.8	1.1	
1.5	0.33	2	16.63	6.787	123.3	0.081	-8.2	0.244	-33.2	1.1	
1.9	0.359	-7.4	16.16	6.424	110.3	0.079	-8.4	0.241	-44.4	1.1	
2.0	0.365	-9.8	16.05	6.343	107.2	0.078	-8.4	0.239	-47.2	1.1	
2.5	0.386	-21	15.49	5.948	91.9	0.077	-7.8	0.221	-61	1.2	
3.0	0.387	-31.5	14.98	5.61	77.4	0.077	-6.7	0.195	-76.8	1.2	
3.5	0.381	-43	14.49	5.301	63.1	0.078	-5.5	0.168	-96.2	1.3	
4.0	0.363	-56	14.02	5.025	49	0.081	-4.3	0.153	-120.3	1.3	
4.5	0.344	-70.7	13.58	4.777	35	0.086	-3.5	0.157	-146.9	1.3	
5.0	0.323	-87.3	13.04	4.488	21	0.093	-3.7	0.172	-169.4	1.2	
5.5	0.31	-105.8	12.54	4.235	7.5	0.101	-4.6	0.195	173.4	1.2	
6.0	0.301	-123.6	11.98	3.971	-6.2	0.111	-6.9	0.22	158.2	1.2	
6.5	0.281	-140.6	11.44	3.735	-19.4	0.124	-10.2	0.239	141.4	1.1	
7.0	0.257	-159.9	10.9	3.507	-32.7	0.138	-15.2	0.262	122.5	1.1	
7.5	0.228	176.3	10.29	3.271	-46.3	0.151	-21.5	0.294	103	1.1	
8.0	0.212	145.6	9.61	3.022	-59.8	0.161	-28.6	0.333	84.3	1.1	
8.5	0.218	117.8	8.72	2.728	-72.4	0.169	-35.6	0.38	69.5	1.1	
9.0	0.257	92.7	7.94	2.494	-84.1	0.178	-41.8	0.429	57.9	1.1	
9.5	0.302	72.9	6.98	2.234	-96.4	0.189	-48.9	0.482	47.9	1	
10.0	0.359	57.7	6.11	2.02	-107.7	0.196	-56.4	0.531	39.2	1	

**Notes:**

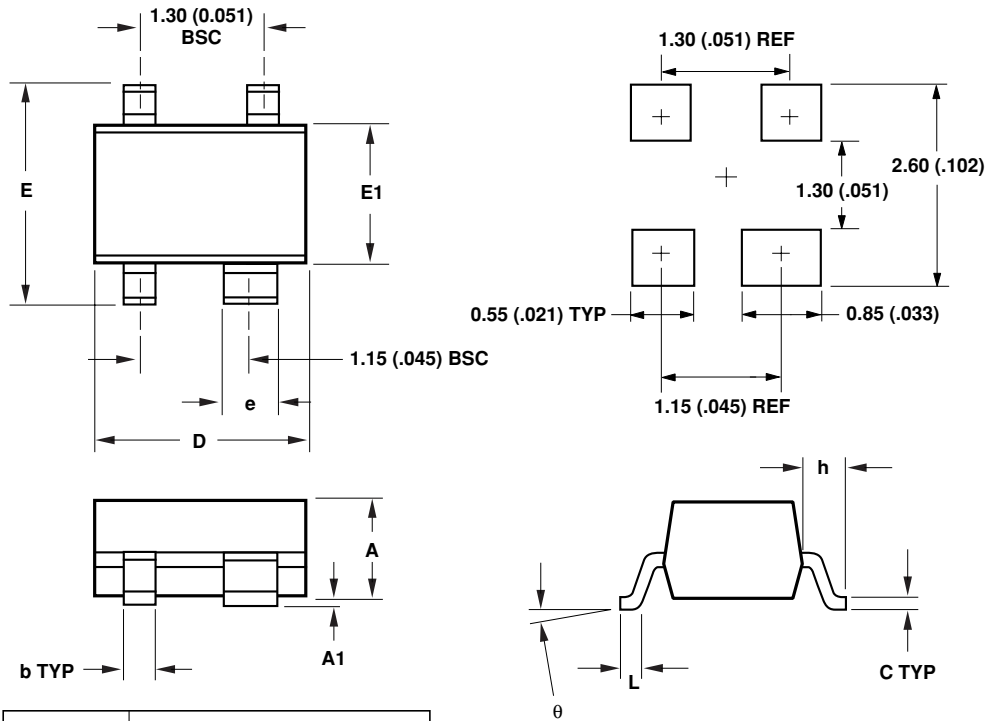
1. S-parameters are measured on a microstrip line made on 0.025 inch thick alumina carrier. The input reference plane is at the end of the input lead. The output reference plane is at the end of the output lead.



## Ordering Information

Part Number	No. of Devices	Container
ADA-4643-TR1	3000	7" Reel
ADA-4643-TR2	10000	13" Reel
ADA-4643-BLK	100	antistatic bag

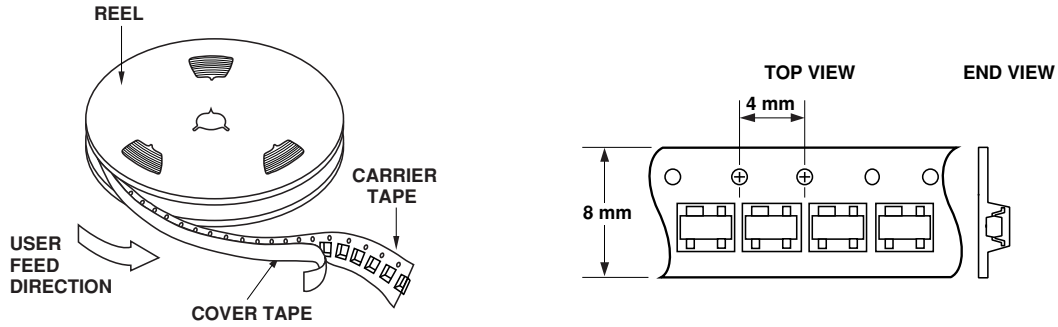
## Package Dimensions Outline 43 SOT-343 (SC70 4-lead)



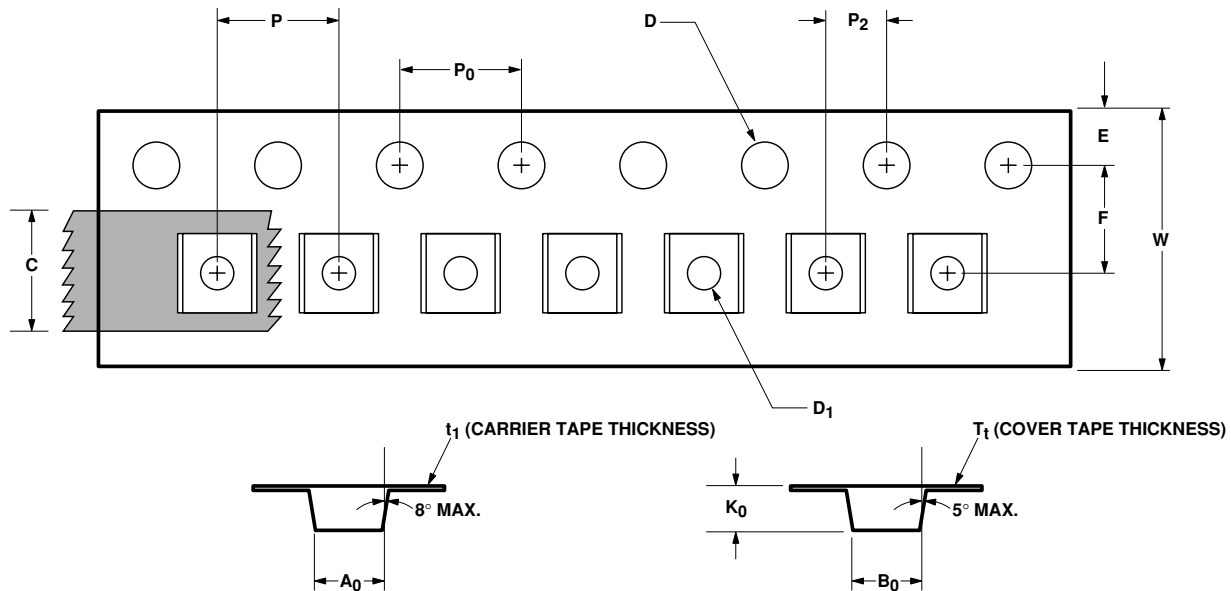
SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	0.80 (0.031)	1.00 (0.039)
A1	0 (0)	0.10 (0.004)
b	0.25 (0.010)	0.35 (0.014)
C	0.10 (0.004)	0.20 (0.008)
D	1.90 (0.075)	2.10 (0.083)
E	2.00 (0.079)	2.20 (0.087)
e	0.55 (0.022)	0.65 (0.025)
h	0.450 TYP (0.018)	
E1	1.15 (0.045)	1.35 (0.053)
L	0.10 (0.004)	0.35 (0.014)
θ	0	10

DIMENSIONS ARE IN MILLIMETERS (INCHES)

## Device Orientation



## Tape Dimensions For Outline 4T



DESCRIPTION		SYMBOL	SIZE (mm)	SIZE (INCHES)
CAVITY	LENGTH	$A_0$	$2.24 \pm 0.10$	$0.088 \pm 0.004$
	WIDTH	$B_0$	$2.34 \pm 0.10$	$0.092 \pm 0.004$
	DEPTH	$K_0$	$1.22 \pm 0.10$	$0.048 \pm 0.004$
	PITCH	$P$	$4.00 \pm 0.10$	$0.157 \pm 0.004$
	BOTTOM HOLE DIAMETER	$D_1$	$1.00 + 0.25$	$0.039 + 0.010$
PERFORATION	DIAMETER	$D$	$1.55 \pm 0.05$	$0.061 \pm 0.002$
	PITCH	$P_0$	$4.00 \pm 0.10$	$0.157 \pm 0.004$
	POSITION	$E$	$1.75 \pm 0.10$	$0.069 \pm 0.004$
CARRIER TAPE	WIDTH	$W$	$8.00 \pm 0.30$	$0.315 \pm 0.012$
	THICKNESS	$t_1$	$0.255 \pm 0.013$	$0.010 \pm 0.0005$
COVER TAPE	WIDTH	$C$	$5.4 \pm 0.10$	$0.205 \pm 0.004$
	TAPE THICKNESS	$T_t$	$0.062 \pm 0.001$	$0.0025 \pm 0.00004$
DISTANCE	CAVITY TO PERFORATION (WIDTH DIRECTION)	$F$	$3.50 \pm 0.05$	$0.138 \pm 0.002$
	CAVITY TO PERFORATION (LENGTH DIRECTION)	$P_2$	$2.00 \pm 0.05$	$0.079 \pm 0.002$

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